

LINEAR TECHNOLOGY MATERIALS DECLARATION

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(Engineering Calculation)

MSOP-Exposed

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TOTAL MASS (g) : 0.026888

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001638	1000000	60919.3125		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	388016.59375		
		Iron (Fe)	7439-89-6	0.000257	24000	9558.15820312		
		Phosphorus (P)	7723-14-0	0.000003	300	111.57383728		
		Zinc (Zn)	7440-66-6	0.000007	700	260.33895874		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.010700	1000000	397946.6875		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	26406.734375		
		External Plating Total:				0.000710	1000000	26406.734375
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3198.44970703		
Internal Plating Total:				0.000086	1000000	3198.44970703		
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000603	750000	22426.3378906		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000201	250000	7475.44628906		
Die Attach Total:				0.000804	1000000	29901.7851562		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	61700.3242188		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	393892.8125		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	16624.5		
		Carbon Black (C)	1333-86-4	0.000064	5000	2380.24169922		
		Encapsulation Total:				0.012761	1000000	474597.875
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000189	1000000	7029.15087891		
					TOTAL MASS (g) :	0.026888		